



SMALL SIGNAL COMPLEMENTARY PRE-BIASED DUAL TRANSISTOR

Features

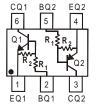
- Epitaxial Planar Die Construction
- Built-In Biasing Resistors
- Surface Mount Package Suited for Automated Assembly
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

R1(NOM)	R2(NOM)
4.7kΩ	47kΩ



Mechanical Data

- Case: SOT363
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 (2)
- Weight: 0.006 grams (Approximate)



Device Schematic

Ordering Information (Note 5)

Product	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
ACX143ZUQ-7R	Automotive	1Y4	7	8	3,000
ACX143ZUQ-13R	Automotive	1Y4	13	8	10,000

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

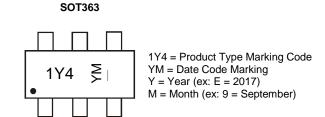
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to https://www.diodes.com/quality/product-compliance-definitions/.

5. -7R /-13R are parts rotated in the pocket tape by +180°.

For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



Date Code Key

Notes:

Year	2017	2018	2019	2020) 202	1 20	22 2	023	2024	2025	2026	2027
Code	E	F	G	Н			J	K	L	М	Ν	0
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Absolute Maximum Ratings - NPN Section (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Supply Voltage <pin: (1)="" (6)="" to=""></pin:>	Vcc	50	V
Input Voltage <pin: (1)="" (2)="" to=""></pin:>	VIN	-10 to +30	V
Output Current	Io	100	mA
Output Current	I _C (Max)	100	mA

Absolute Maximum Ratings - PNP Section (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Supply Voltage <pin: (3)="" (4)="" to=""></pin:>	V _{CC}	-50	V
Input Voltage <pin: (4)="" (5)="" to=""></pin:>	V _{IN}	+5 to -30	V
Output Current	Io	-100	mA
Output Current	I _C (Max)	-100	mA

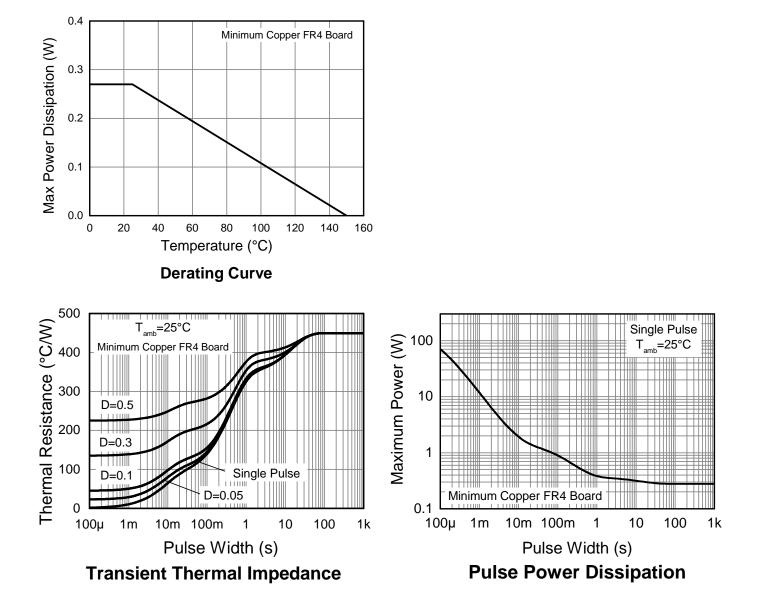
Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation (Notes 6 & 7)	PD	270	mW
Thermal Resistance, Junction to Ambient Air (Note 6)	R _{0JA}	450	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	С°

Notes: 6. Mounted on FR-4 PC Board with minimum recommended pad layout. 7. 150mW per element must not be exceeded.



Thermal Characteristics and Derating Information





Electrical Characteristics - NPN Section (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Input Voltage	VI(OFF) (Note 8)	0.5		_	V	$V_{CC} = 5V, I_{O} = 100\mu A$
input voltage	VI(ON) (Note 9)	—		1.3	v	$V_0 = 0.3V, I_0 = 5mA$
Output Voltage	V _{O(ON)}	_	0.1	0.3	V	$I_0/I_1 = 5mA / 0.25mA$
Input Current	l _l	_	_	1.8	mA	$V_1 = 5V$
Output Current	IO(OFF)	_	_	0.5	μA	$V_{CC} = 50V, V_{I} = 0V$
DC Current Gain	GI	80	_		_	$V_0 = 5V, I_0 = 10mA$
Input Resistor (R1) Tolerance	ΔR_1	-30		+30	%	—
Resistance Ratio Tolerance	$\Delta R_2/R_1$	-20	_	+20	%	—
Gain-Bandwidth Product (Note 10)	fT	_	250	_	MHz	V _{CE} = 10V, I _E = 5mA, f = 100MHz
Notes: 8. Guarantees that the device will be swi	itched OFF if the Input Volt	age is less	s than 0.5\	V.		

B. Guarantees that the device will be switched OFF if the Input Voltage is less than 0.5V.
Guarantees that the device will be switched ON if the Input Voltage is more than 1.3V.

10. Transistor - For Reference Only.

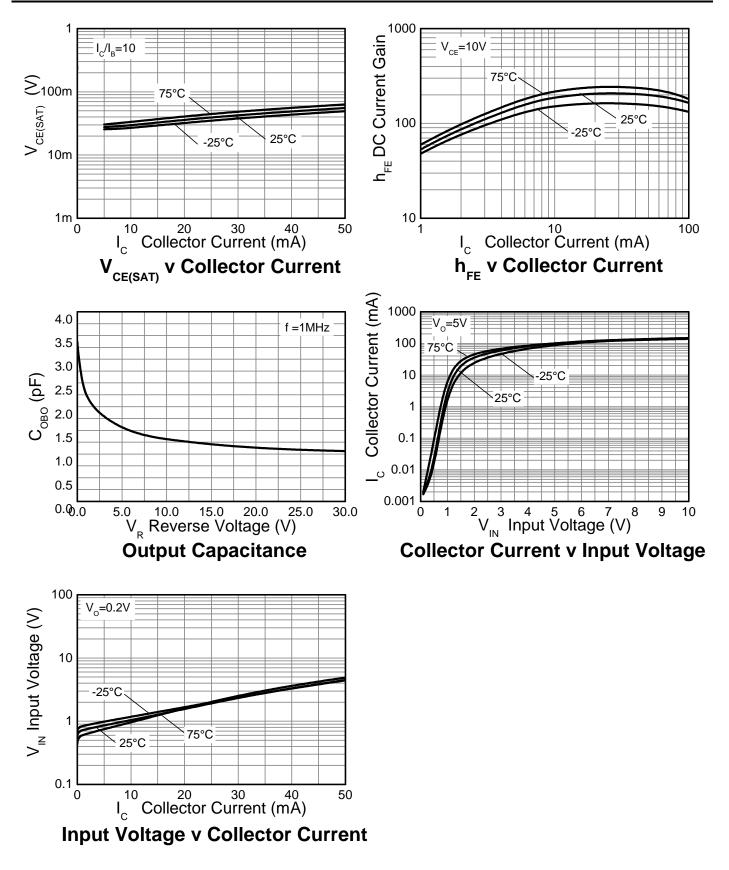
Electrical Characteristics - PNP Section (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Input Voltage	V _{I(OFF)} (Note 11)	-0.5		_	V	$V_{CC} = -5V, I_{O} = -100\mu A$
input voltage	VI(ON) (Note 12)	_	_	-1.3	v	V _O = -0.3V, I _O = -5mA
Output Voltage	V _{O(ON)}		-0.1	-0.3	V	$I_0/I_1 = -5mA / -0.25mA$
Input Current	lı	_	_	-1.8	mA	$V_I = -5V$
Output Current	I _{O(OFF)}	_	_	-0.5	μA	$V_{CC} = 50V, V_1 = 0V$
DC Current Gain	GI	80	_	_	_	$V_0 = -5V, I_0 = -10mA$
Input Resistor (R1) Tolerance	ΔR_1	-30	_	+30	%	—
Resistance Ratio Tolerance	$\Delta R_2/R_1$	-20	_	+20	%	—
Gain-Bandwidth Product (Note 10)	fT		250		MHz	V _{CE} = -10V, I _E = -5mA, f = 100MHz
Notes: 11. Guarantees that the device will be	switched OFF if the Input Volt	age is les	ss than -0.	5V.		· · · · · · · · · · · · · · · · · · ·

Guarantees that the device will be switched OFF if the Input Voltage is less than -0.5V.
Guarantees that the device will be switched ON if the Input Voltage is more than -1.3V.

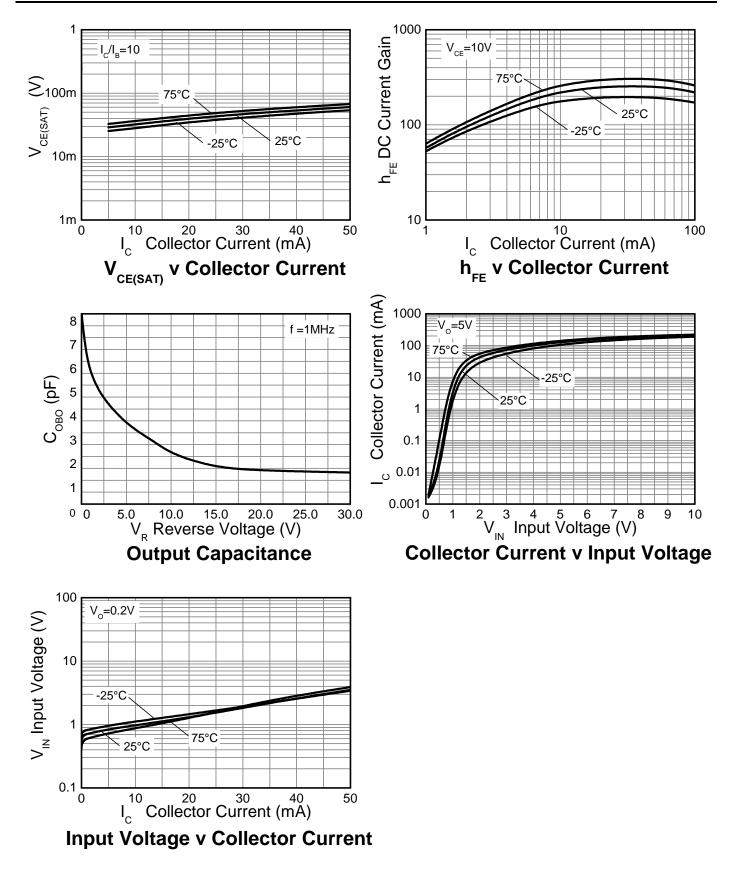


Typical Electrical Characteristics – NPN Section (@T_A = +25°C, unless otherwise specified.)





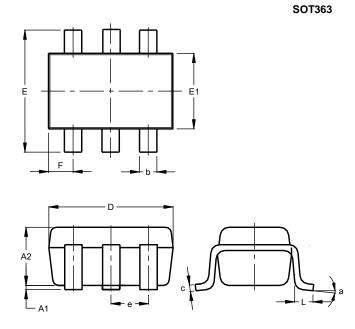
Typical Electrical Characteristics – PNP Section (@T_A = +25°C, unless otherwise specified.)





Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

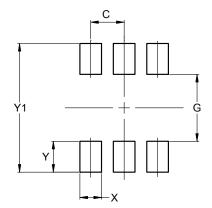


	SOT363							
Dim	Min	Max	Тур					
A1	0.00	0.10	0.05					
A2	0.90	1.00	1.00					
b	0.10	0.30	0.25					
С	0.10	0.22	0.11					
D	1.80	2.20	2.15					
Е	2.00	2.20	2.10					
E1	1.15	1.35	1.30					
е	().650 E	SC					
F	0.40	0.45	0.425					
L	0.25	0.40	0.30					
а	0°	8°						
All	Dimen	sions	in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT363



Dimensions	Value (in mm)
С	0.650
G	1.300
X	0.420
Y	0.600
Y1	2.500



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